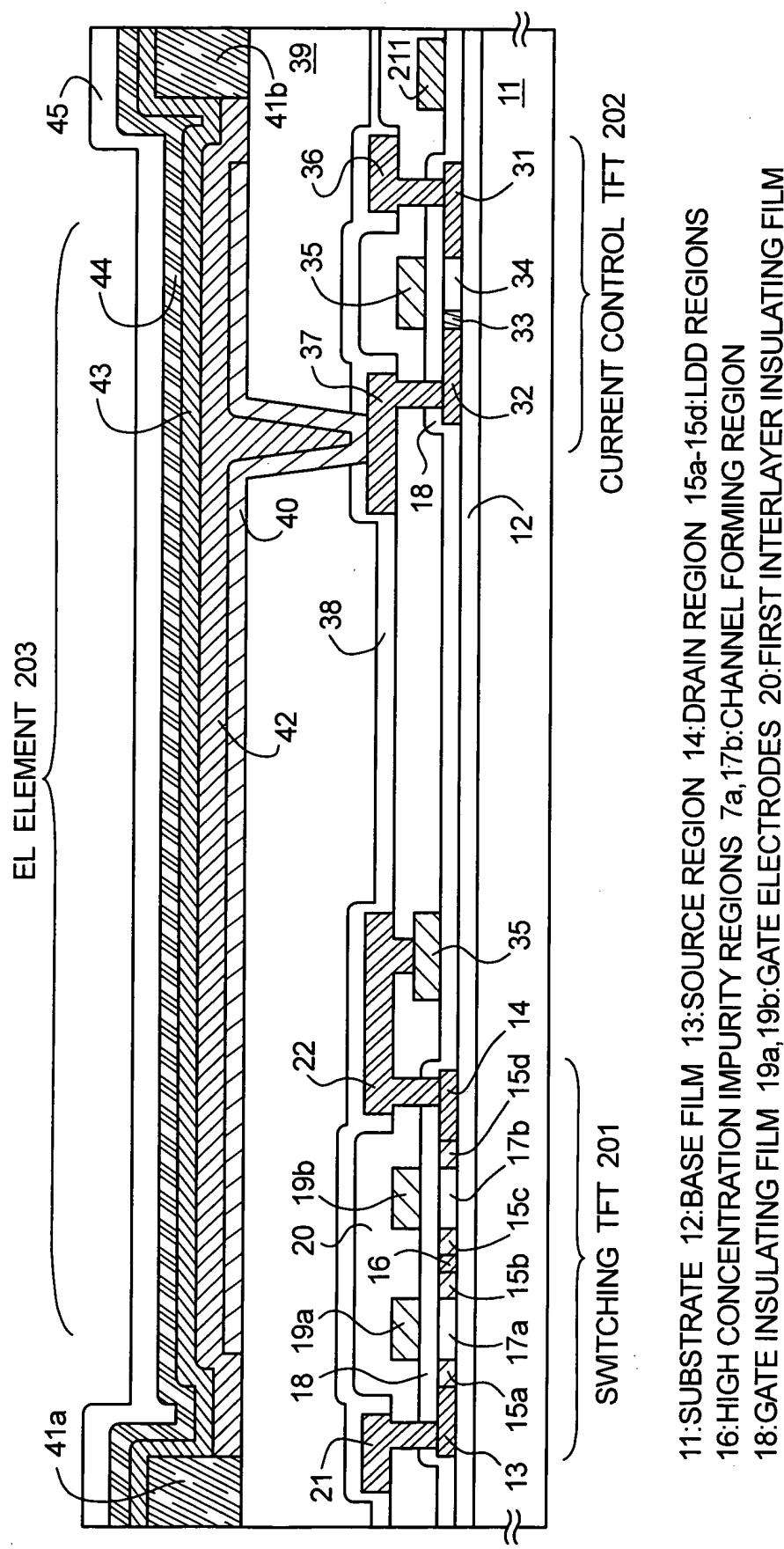
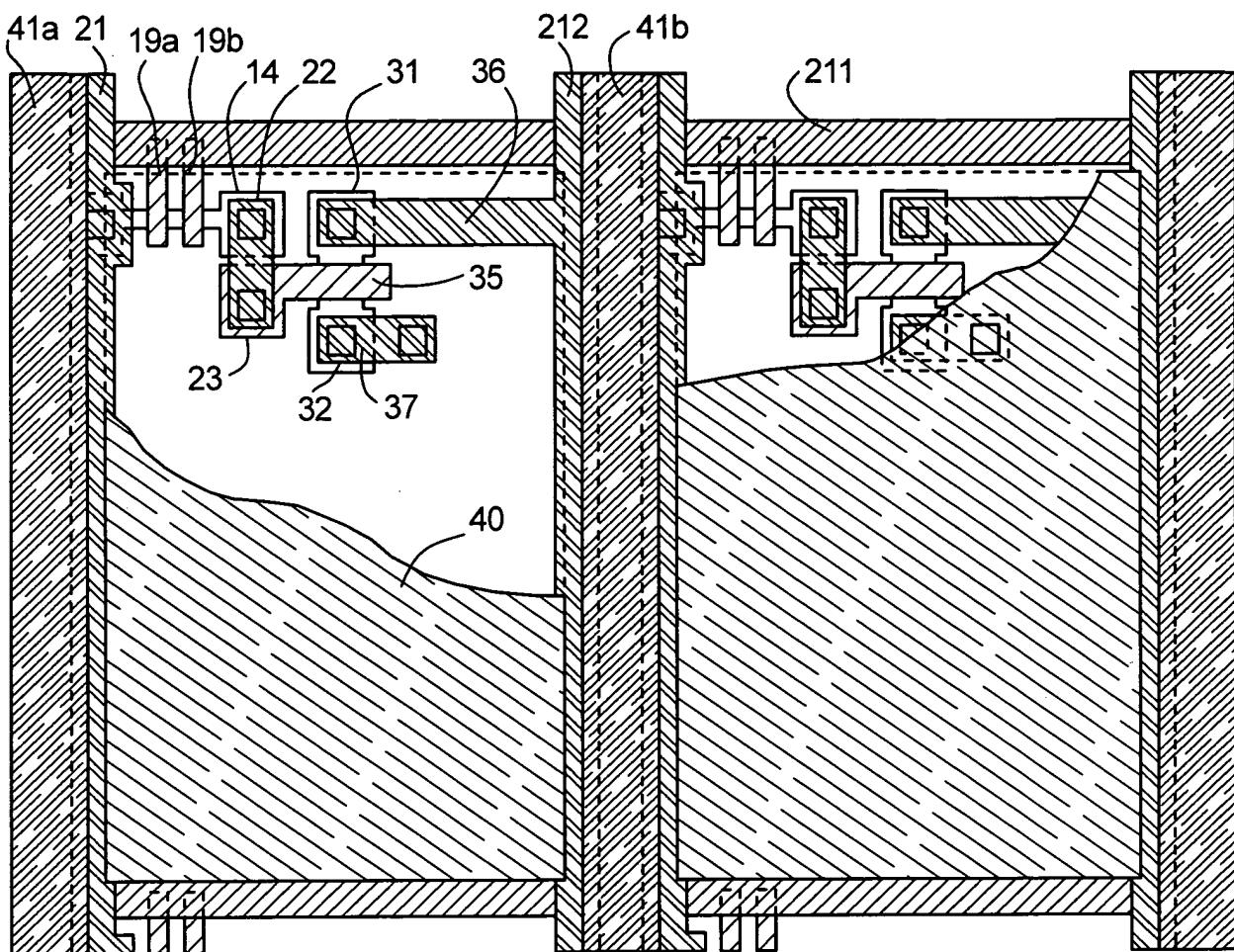


FIG. 1C

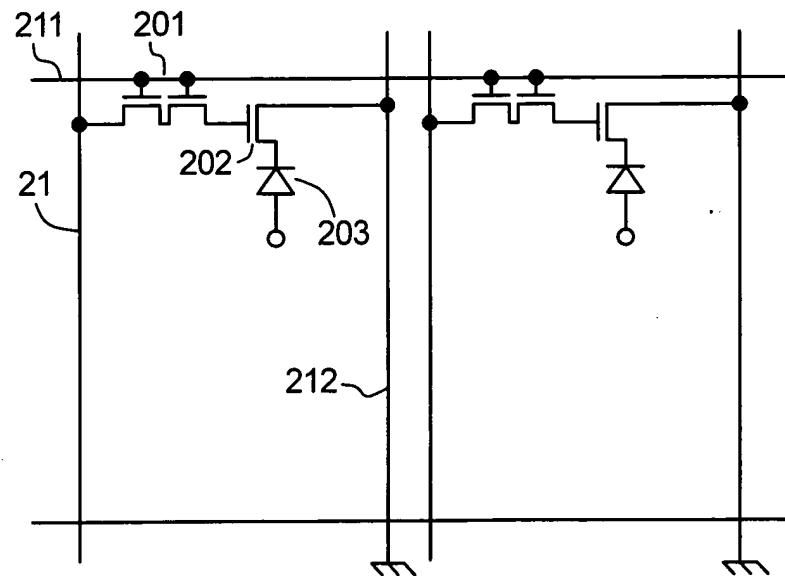


- 11:SUBSTRATE 12:BASE FILM 13:SOURCE REGION 14:DRAIN REGION 15a-15d:LDD REGIONS
- 16:HIGH CONCENTRATION IMPURITY REGIONS 7a,17b:CHANNEL FORMING REGION
- 18:GATE INSULATING FILM 19a, 19b:GATE ELECTRODES 20:FIRST INTERLAYER INSULATING FILM
- 21:SOURCE WIRING 22:DRAIN WIRING 23:GATE ELECTRODE 31:SOURCE REGION 32:DRAIN REGION
- 33:LDD REGION 34:CHANNEL FORMING REGION 35:GATE ELECTRODE 36:SOURCE WIRING
- 37:DRAIN WIRING 38:FIRST PASSIVATION FILM 39:SECOND INTERLAYER INSULATING FILM
- 40:PIXEL ELECTRODE(CATHODE) 41:BANK 42:LIGHT EMITTING LAYER 43:HOLE INJECTION LAYER
- 44:ANODE 45:SECOND INTERLAYER INSULATING FILM

FIG. 2



*FIG. 3A*



*FIG. 3B*

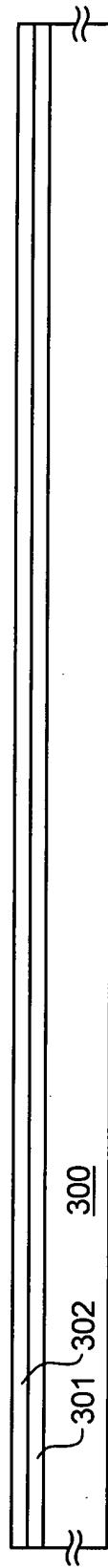


FIG. 4A

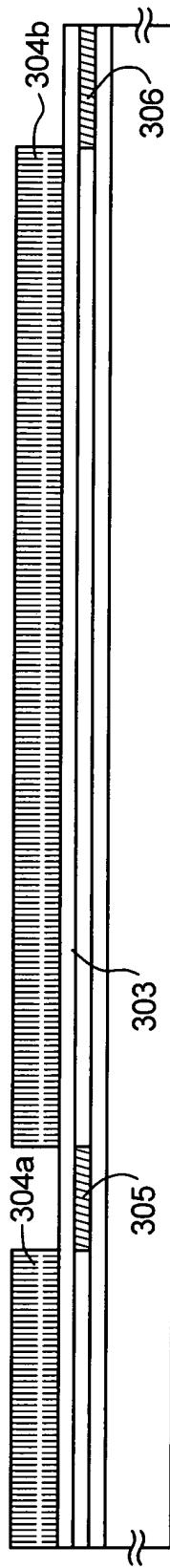


FIG. 4B

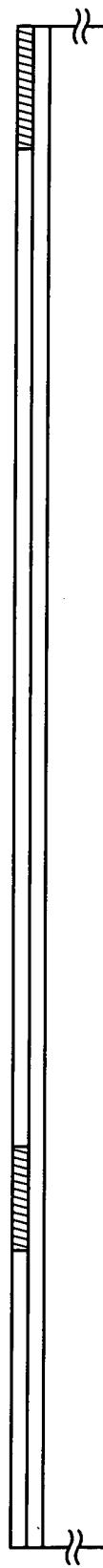


FIG. 4C

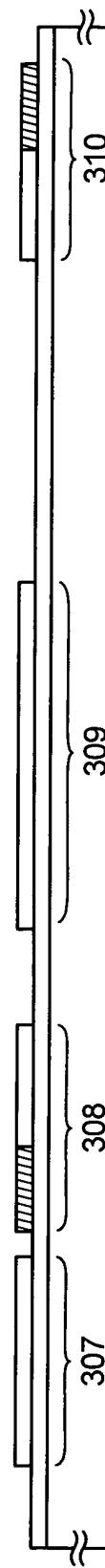


FIG. 4D

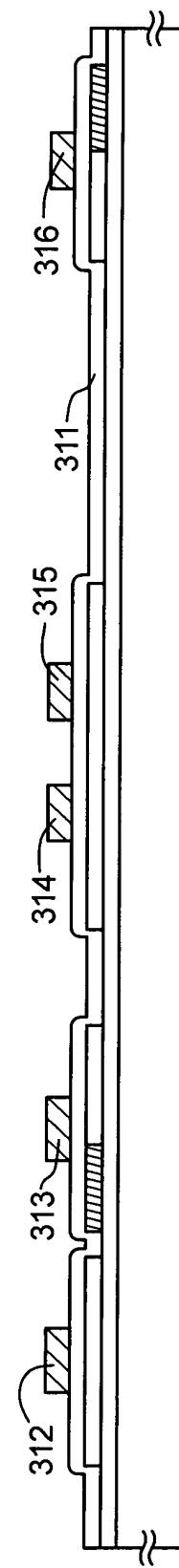


FIG. 4E

300:GLASS SUBSTRATE 301:BASE FILM 302:POLYSILICON FILM 303:PROTECTIVE FILM 304a-304b:RESIST MASK  
305,306:N-TYPE IMPURITY REGIONS 307-310:ACTIVE LAYERS 311:GATE INSULATING FILM 312-316:GATE ELECTRODES

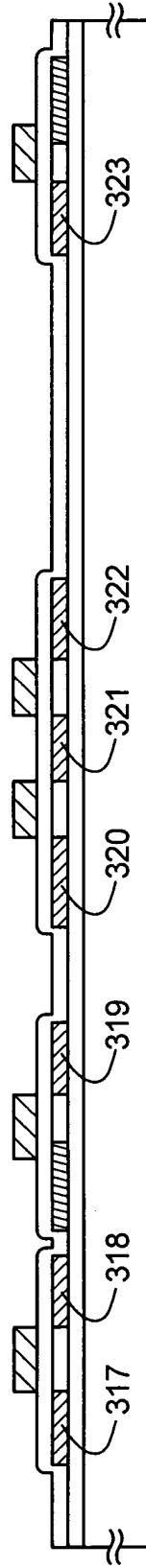


FIG. 5A

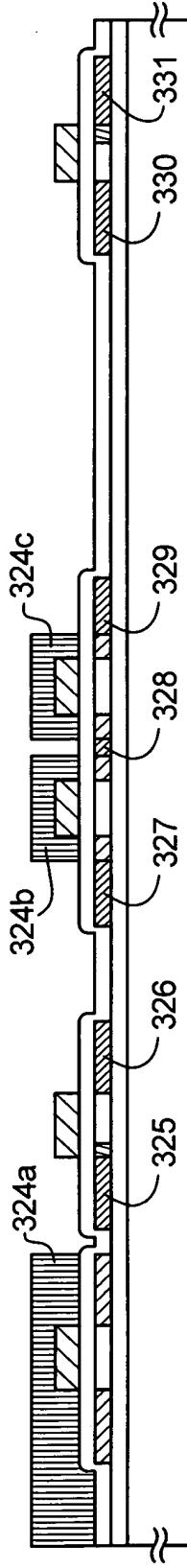


FIG. 5B

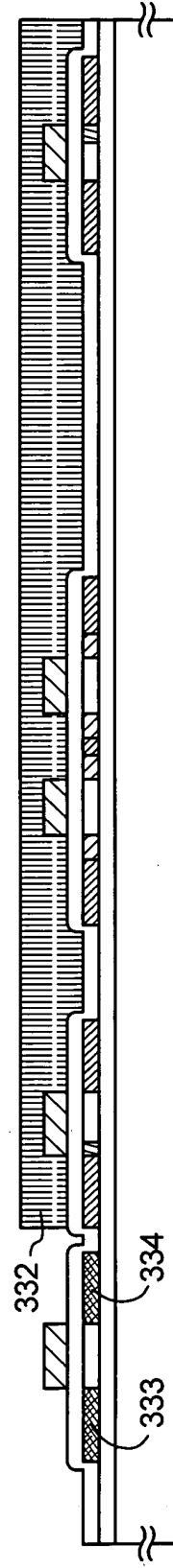


FIG. 5C

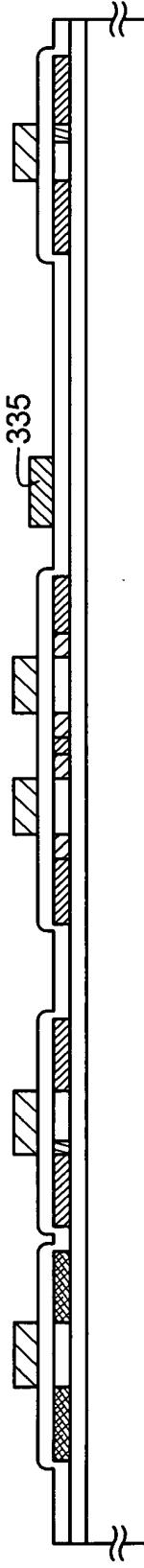
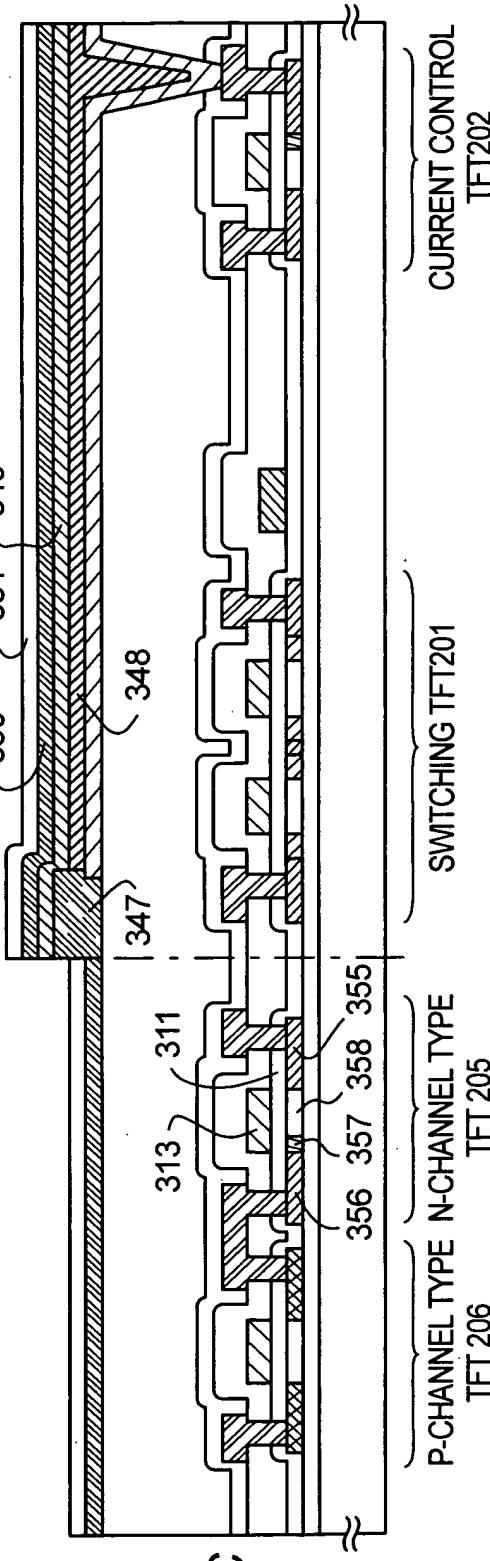
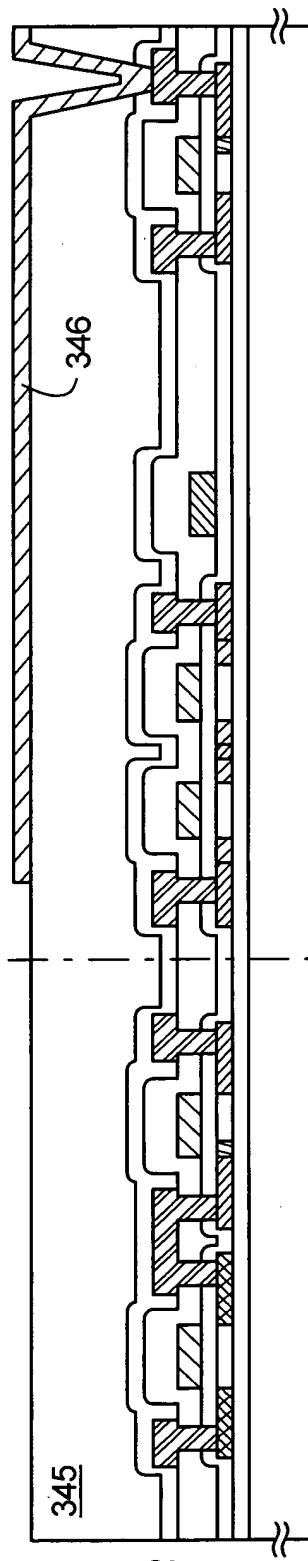
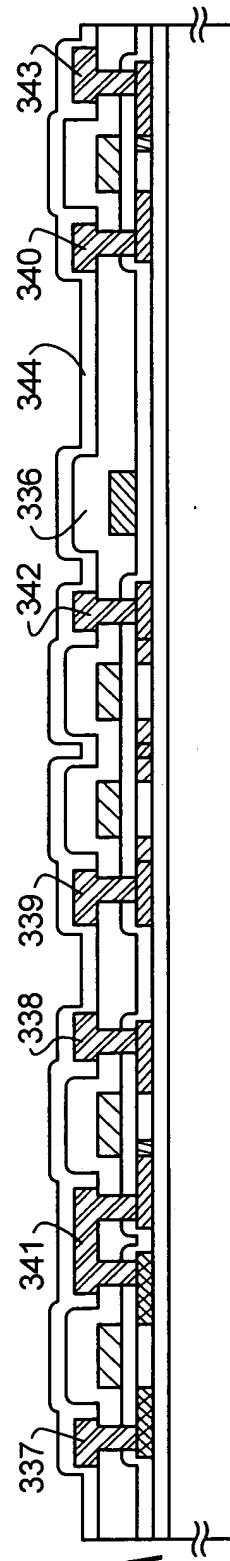


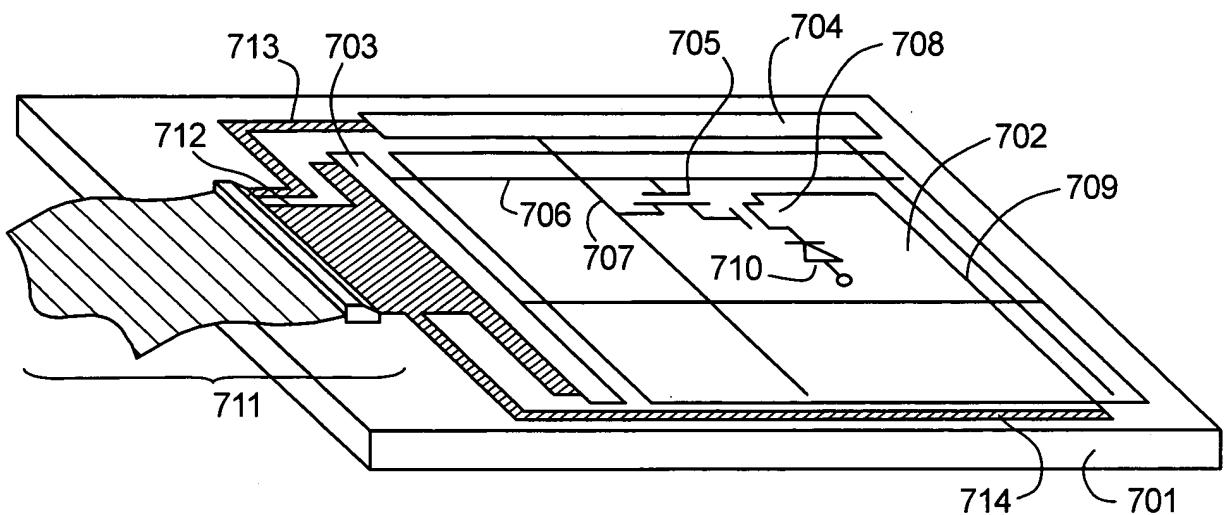
FIG. 5D

317-323:N-TYPE IMPURITY REGIONS 324a-324c,332:RESIST MASK 325-331:N-TYPE IMPURITY REGIONS  
333,334:P-TYPE IMPURITY REGIONS 335:GATE WIRING



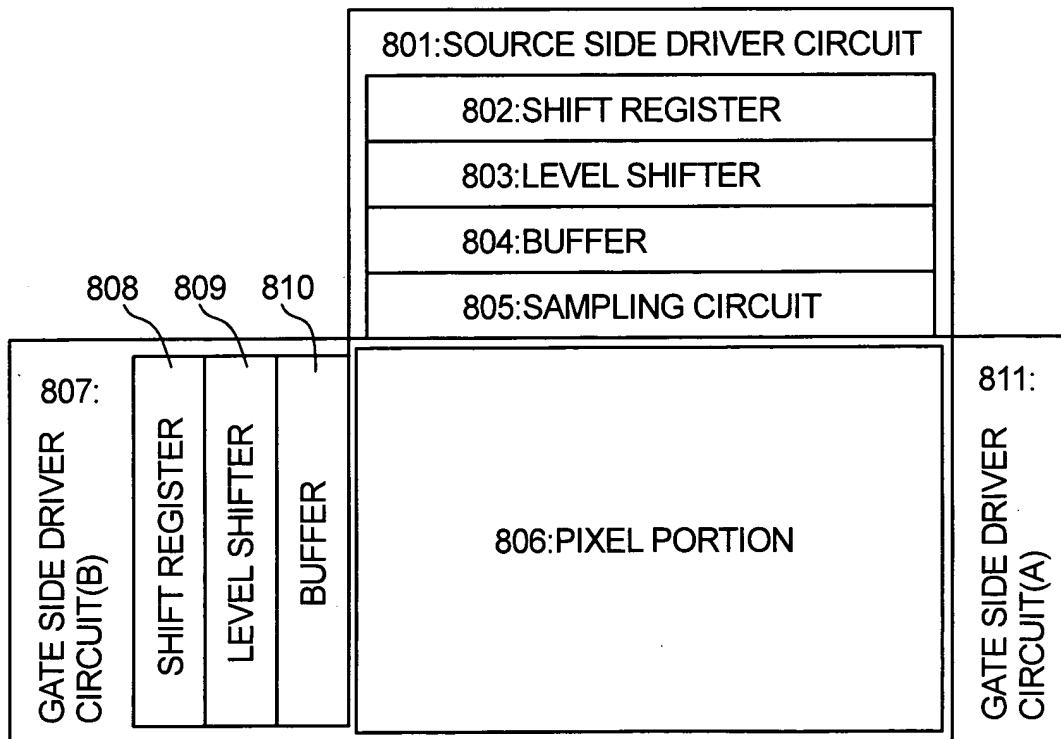
P-CHANNEL TYPE N-CHANNEL TYPE  
TFT 206 TFT 205  
SWITCHING TFT201  
CURRENT CONTROL  
TFT202

336:FIRST INTERLAYER INSULATING FILM 337-340:SOURCE WIRING 341-343:DRAIN WIRING  
344:FIRST PASSIVATION FILM 345:SECOND INTERLAYER INSULATING FILM 346:PIXEL ELECTRODE (CATHODE)  
347:BANK 348:LIGHT EMITTING LAYER 350:HOLE INJECTION LAYER 351:SECOND PASSIVATION FILM



701:SUBSTRATE 702:PIXEL PORTION 703:GATE SIDE DRIVER CIRCUIT  
704:SOURCE SIDE DRIVER CIRCUIT 705:SWITCHING TFT 706:GATE WRING  
707:SOURCE WRING 708:CURRENT CONTROL TFT 709:CURRENT SUPPLY LINE  
710:EL ELEMENT 711:FPC 712-714:CONNECTION WRING

*FIG. 7*



*FIG. 8*

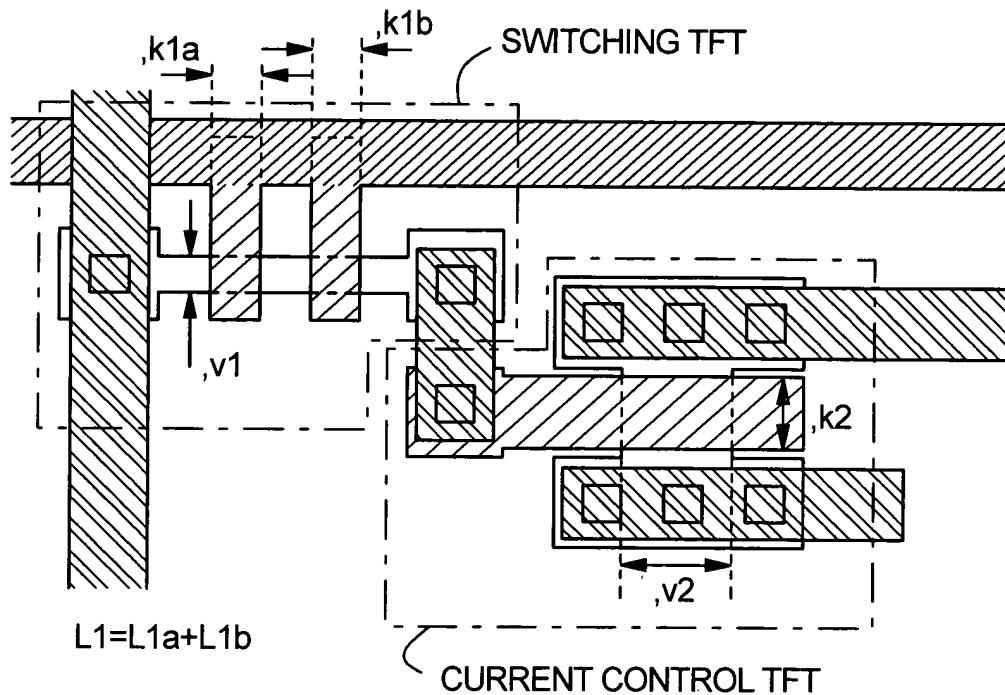


FIG. 9

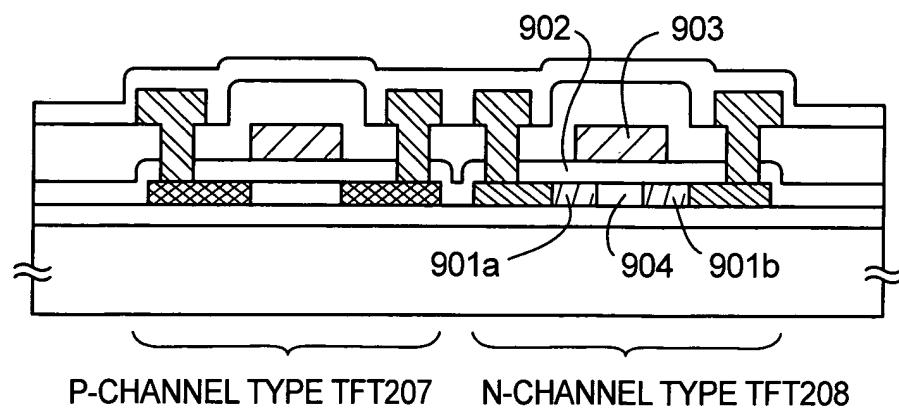
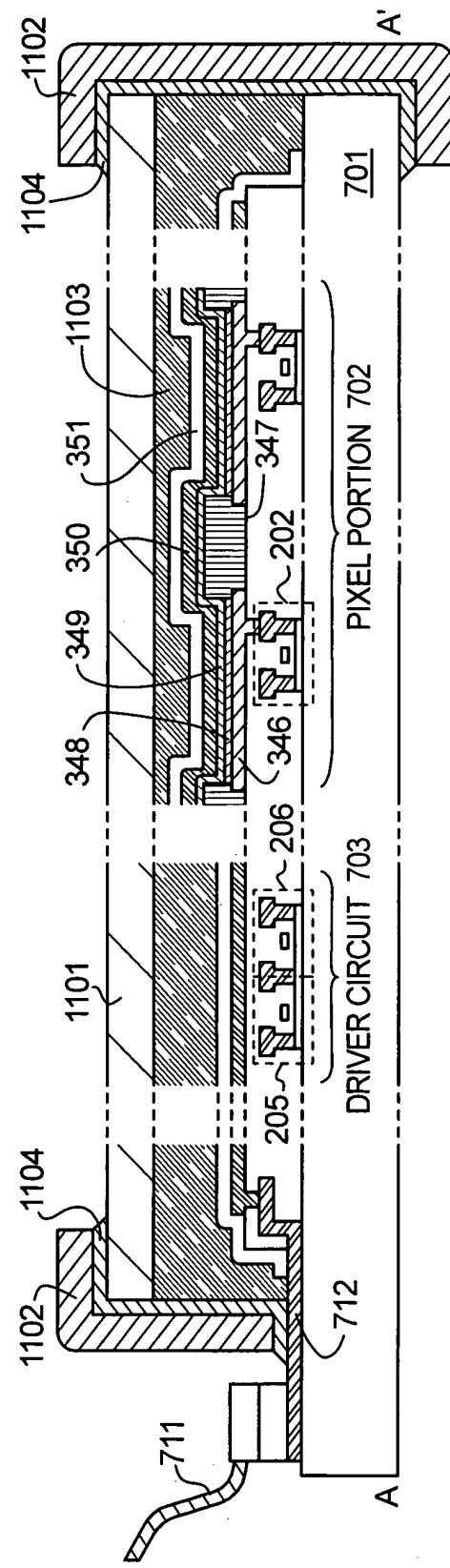
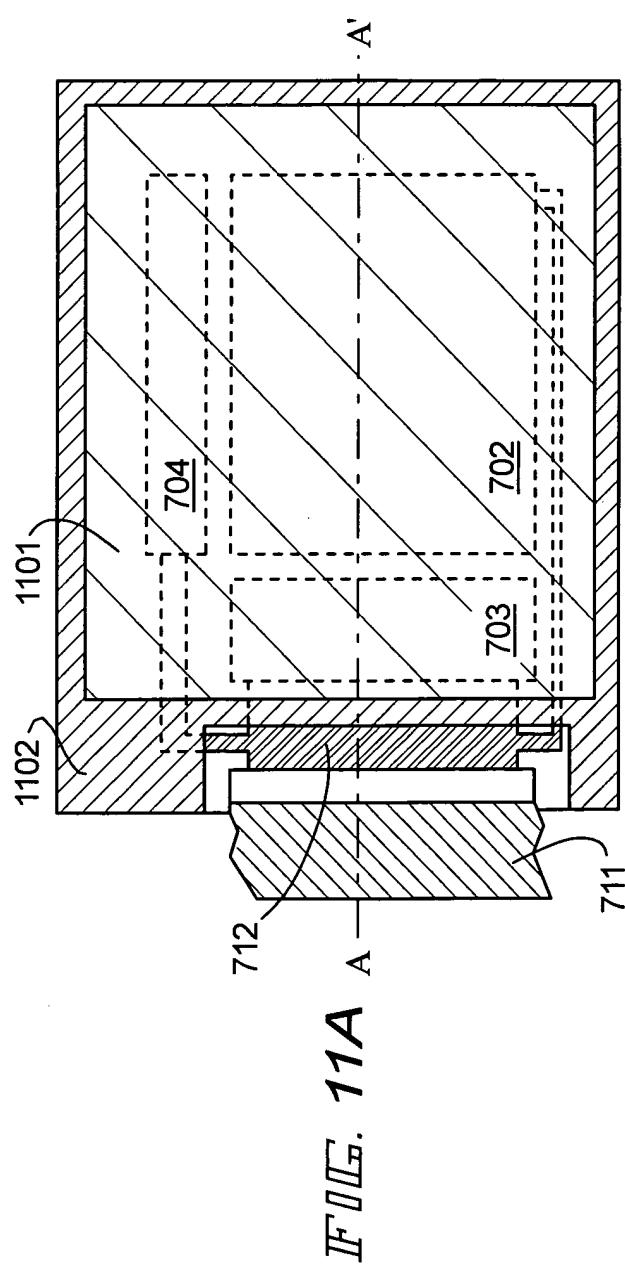


FIG. 10



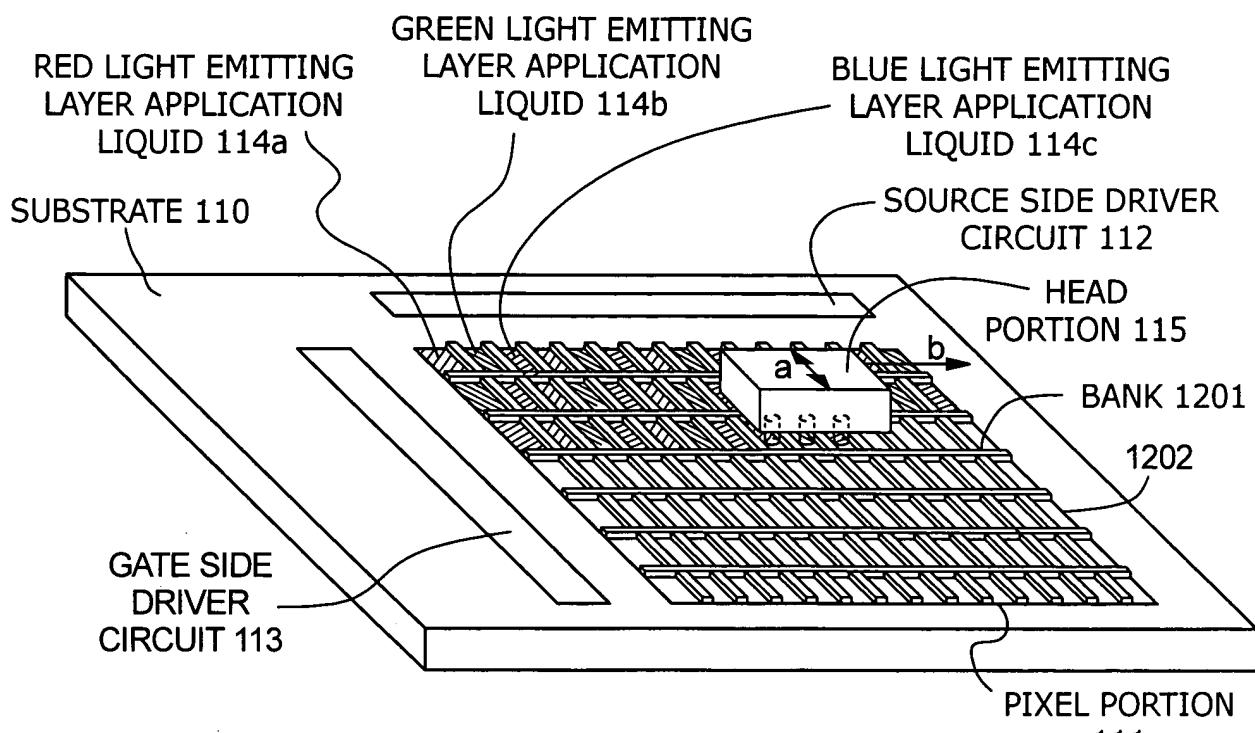


FIG. 12A

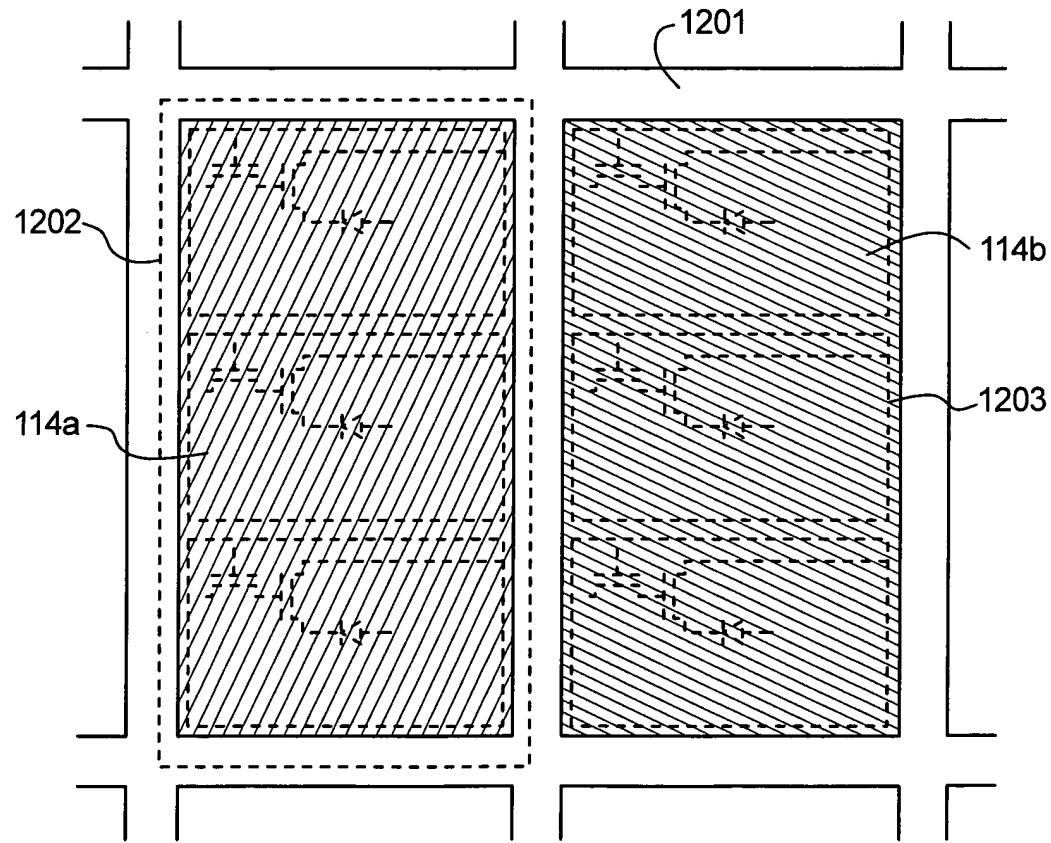


FIG. 12B

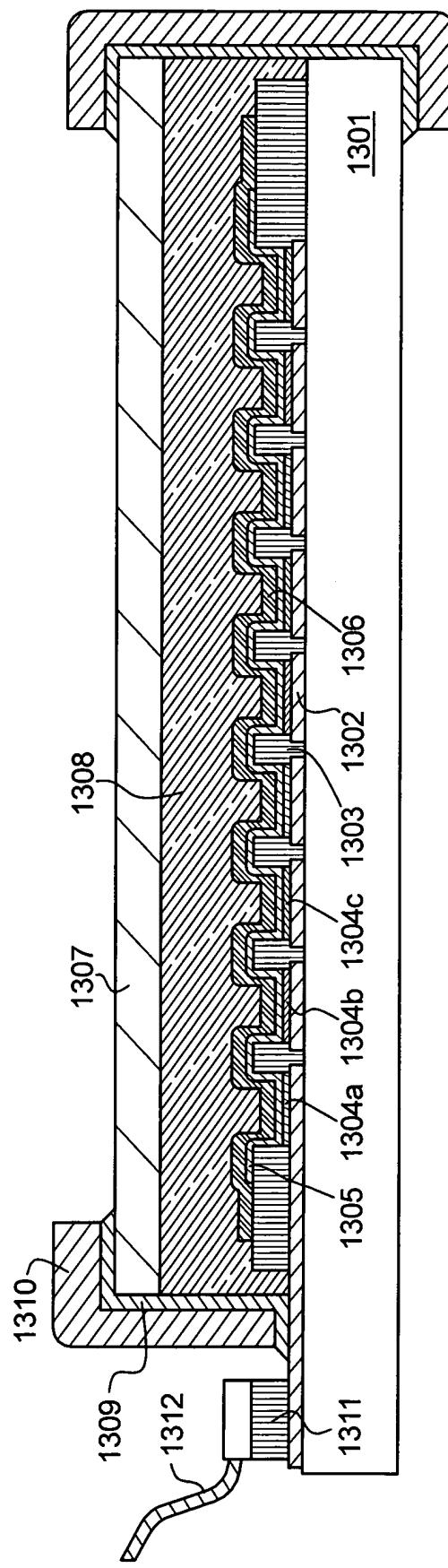


FIG. 13

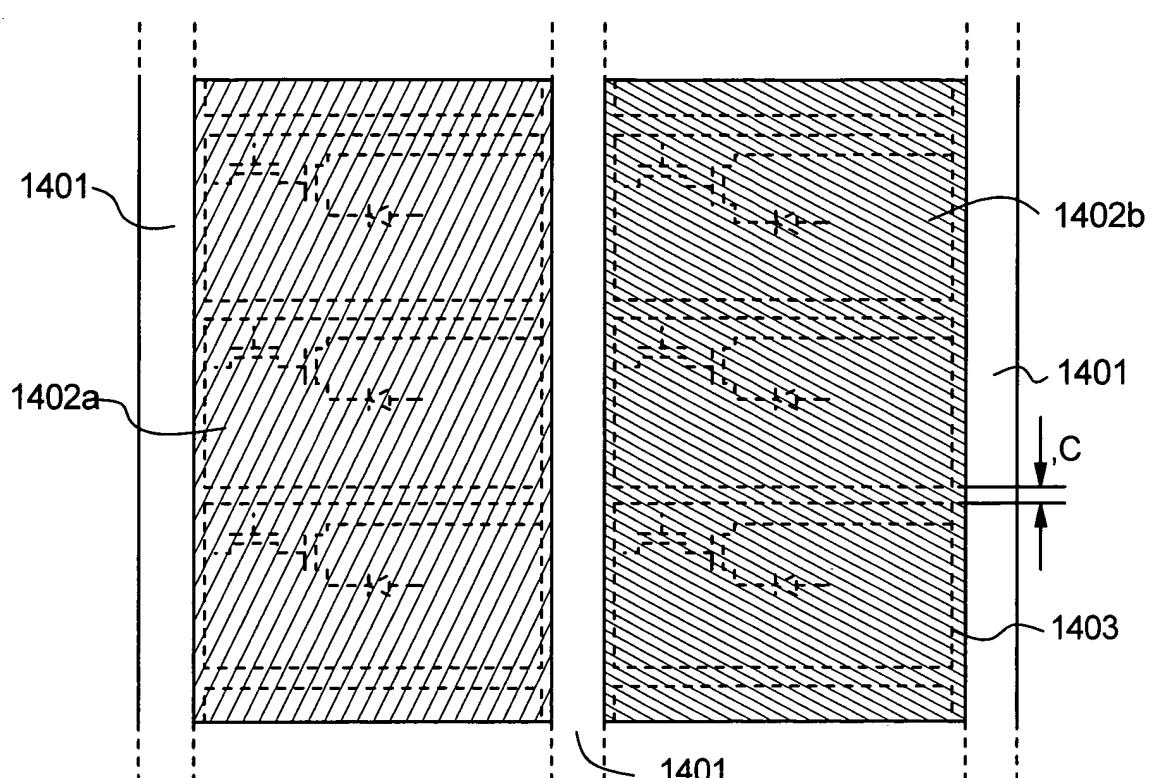


FIG. 14A

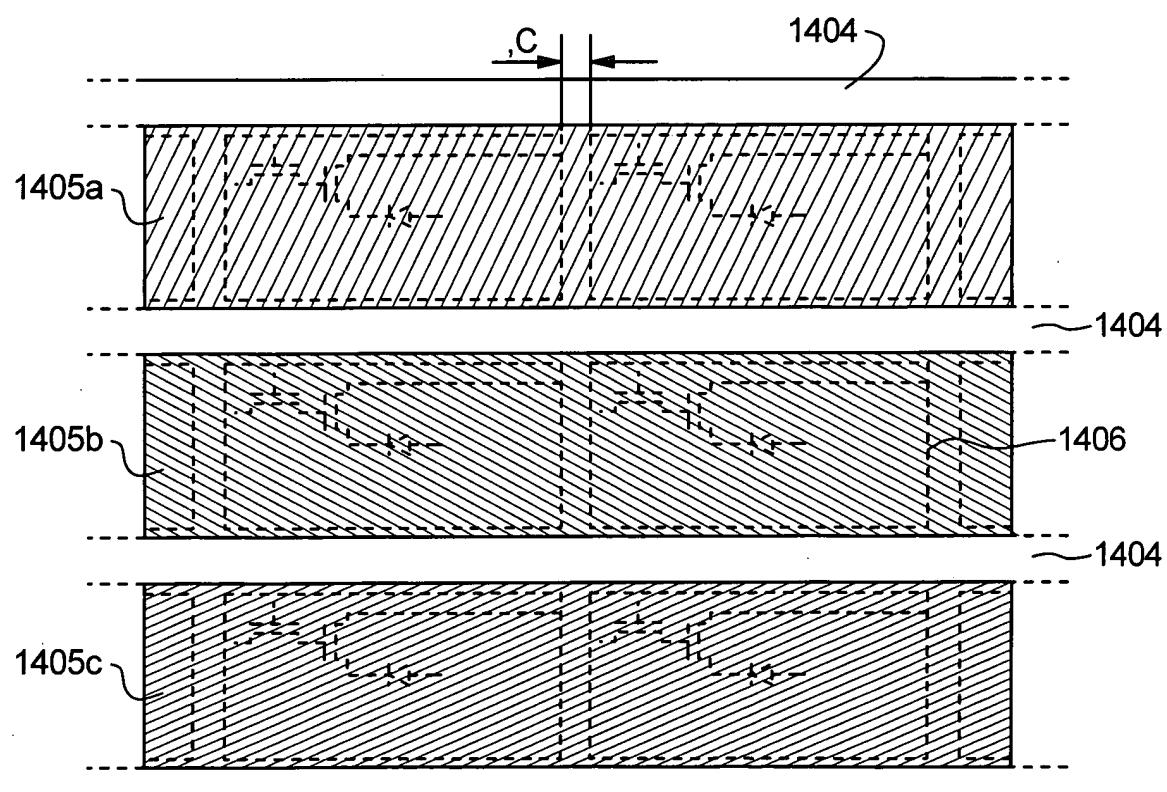


FIG. 14B

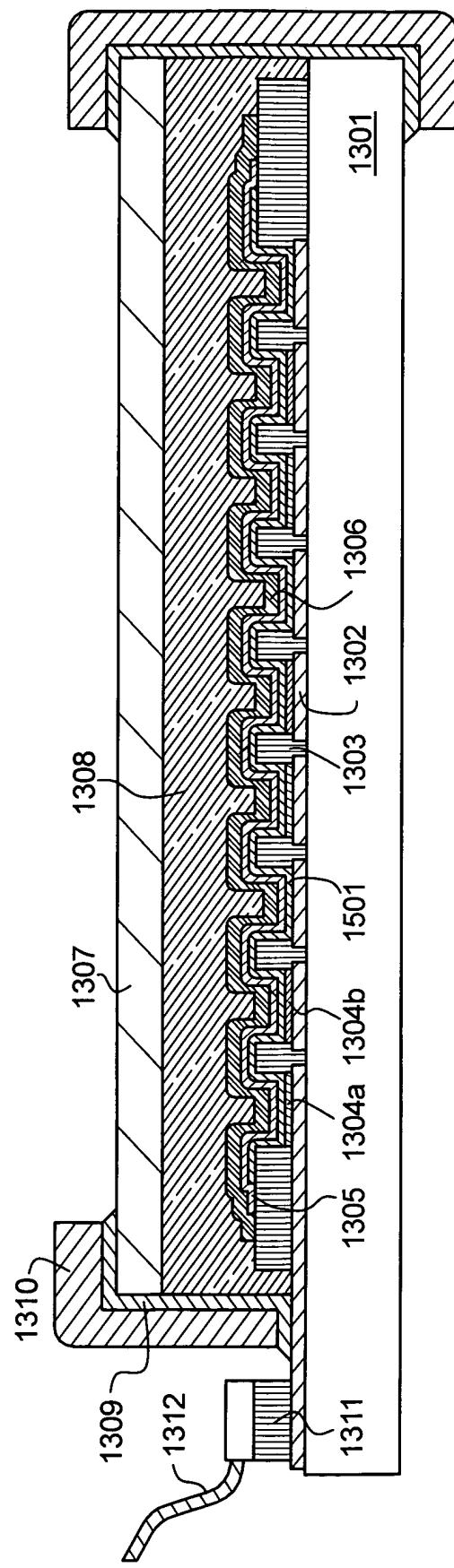


FIGURE. 15

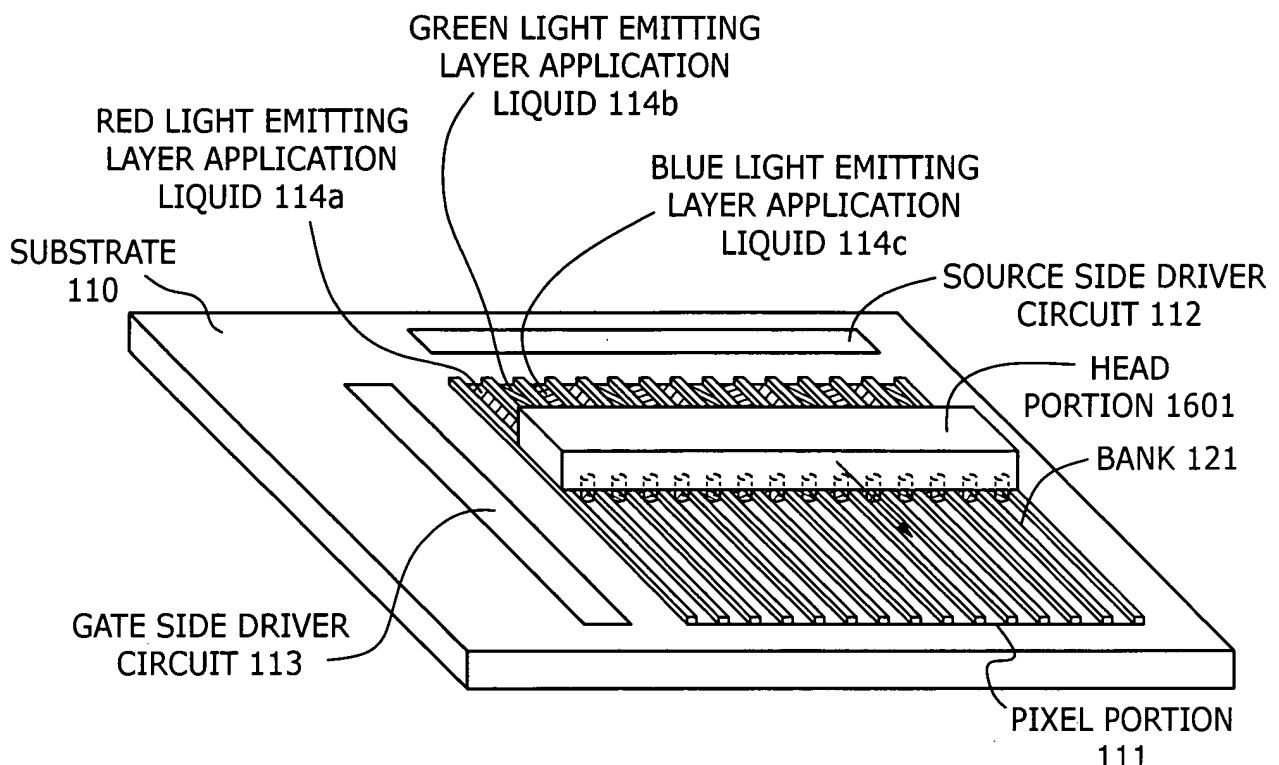


FIG. 16

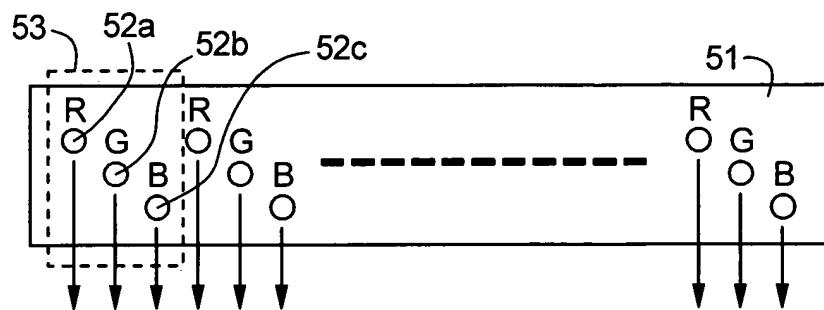


FIG. 17A

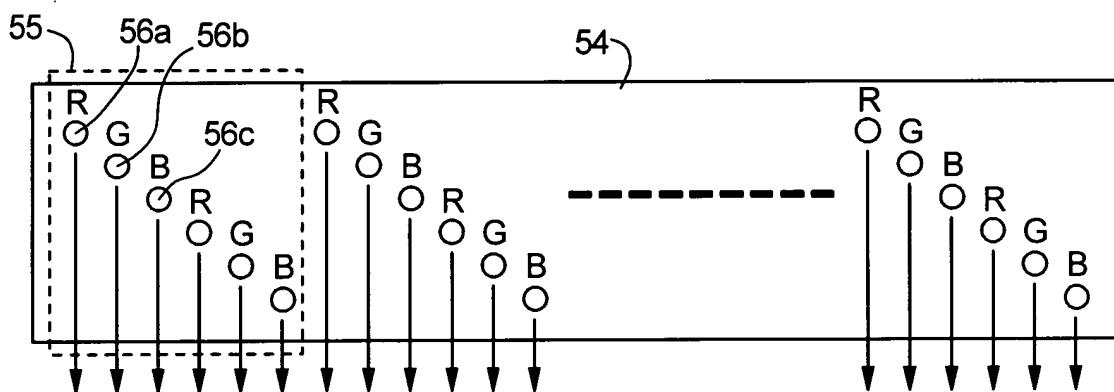


FIG. 17B

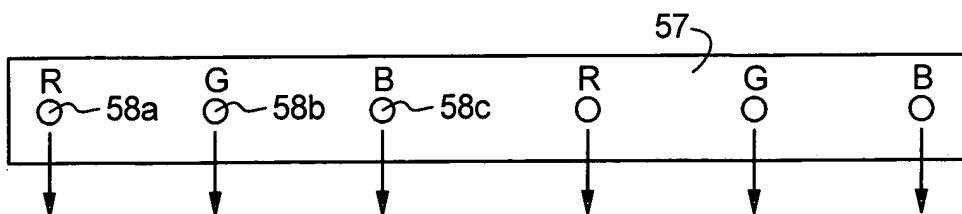
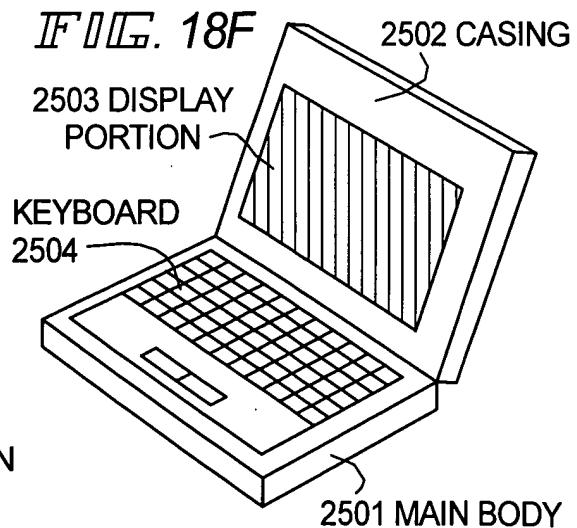
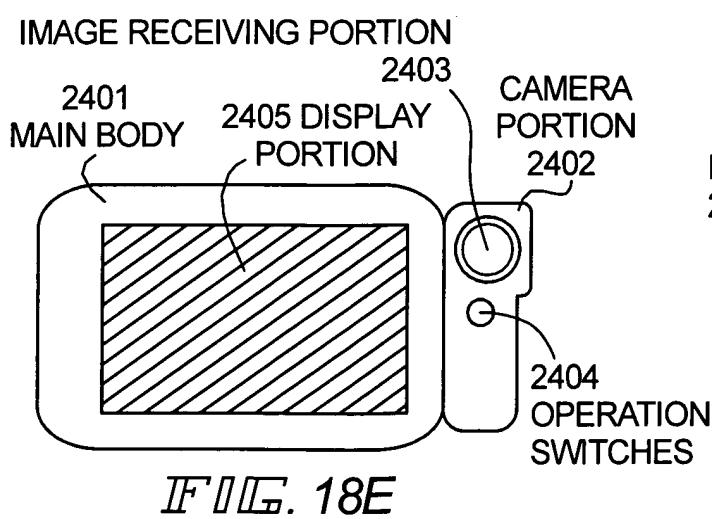
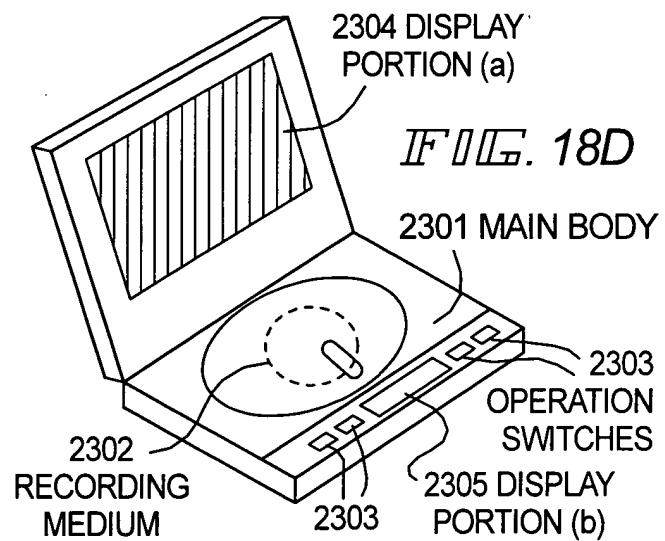
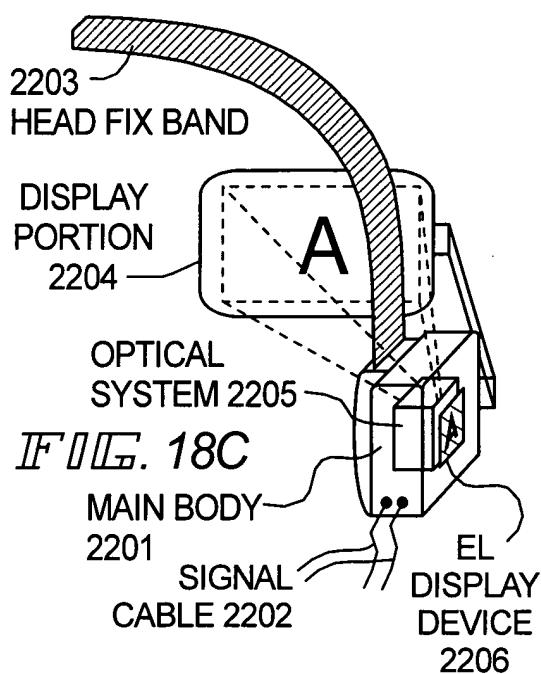
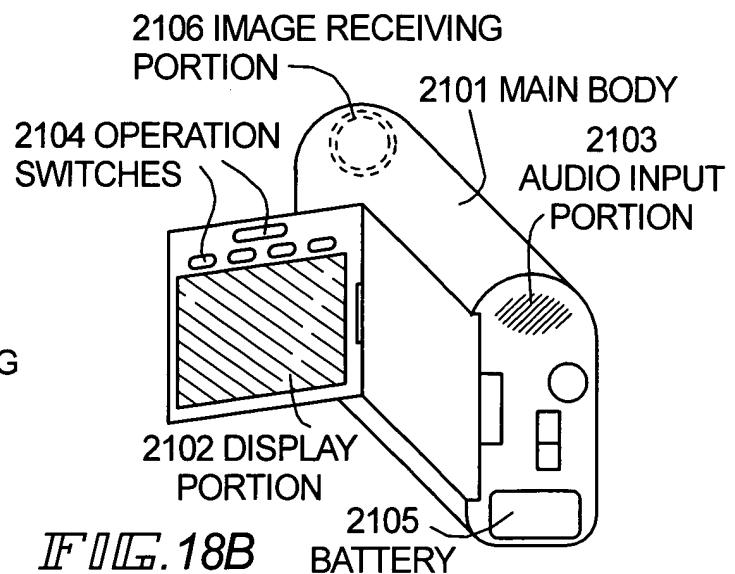
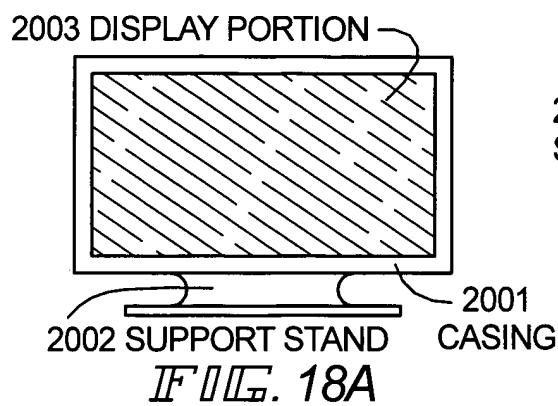


FIG. 17C



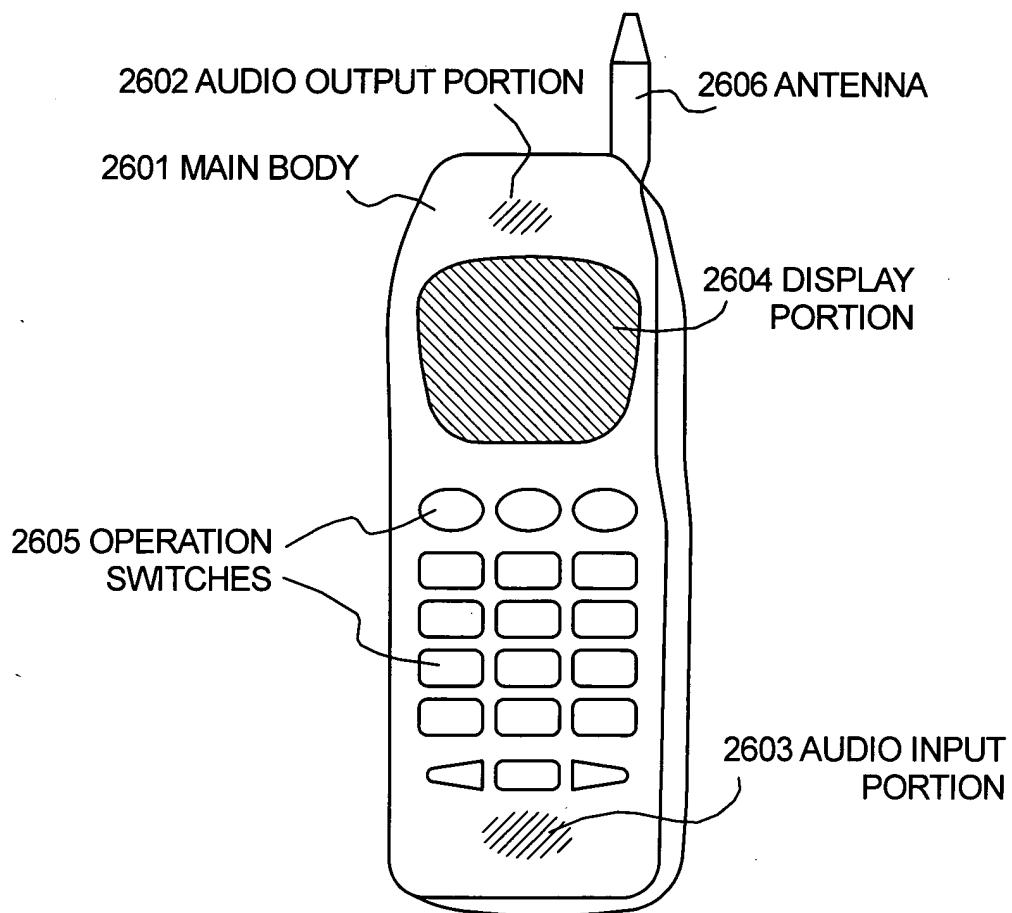


FIG. 19A

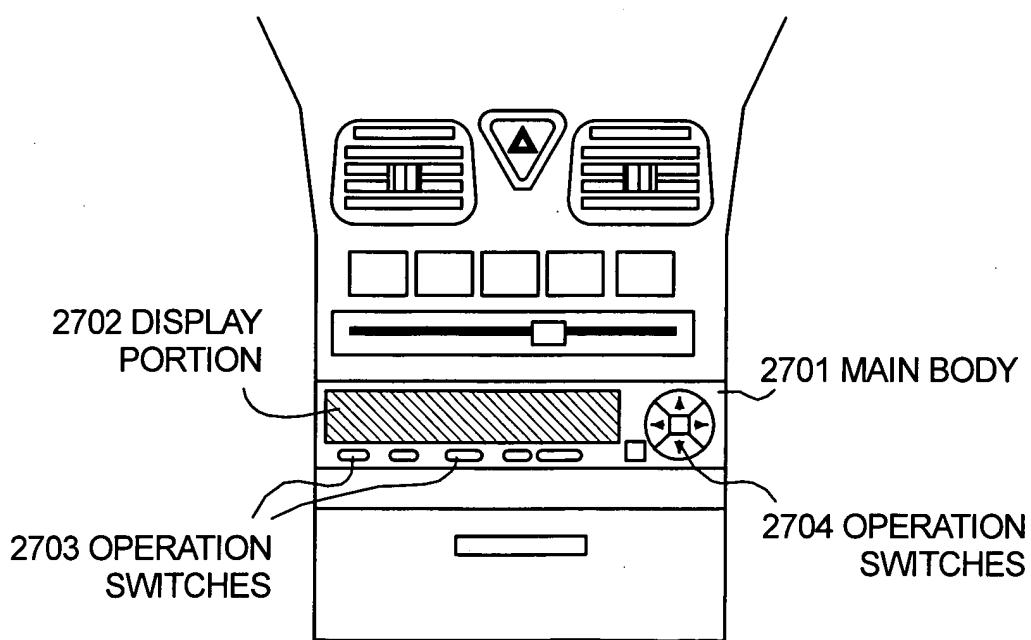


FIG. 19B

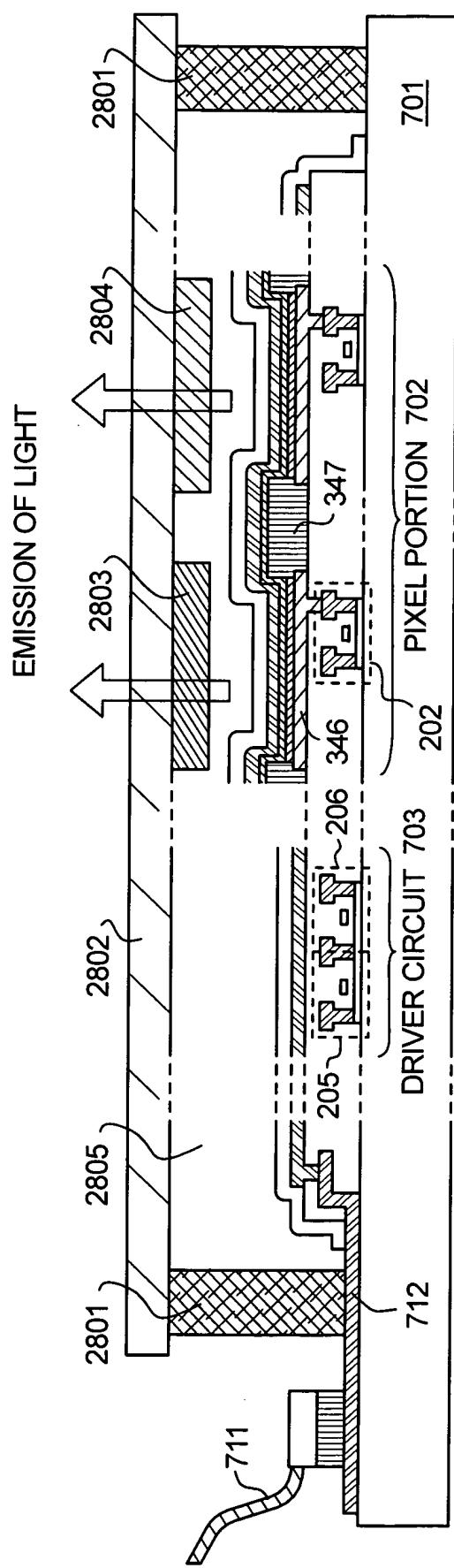
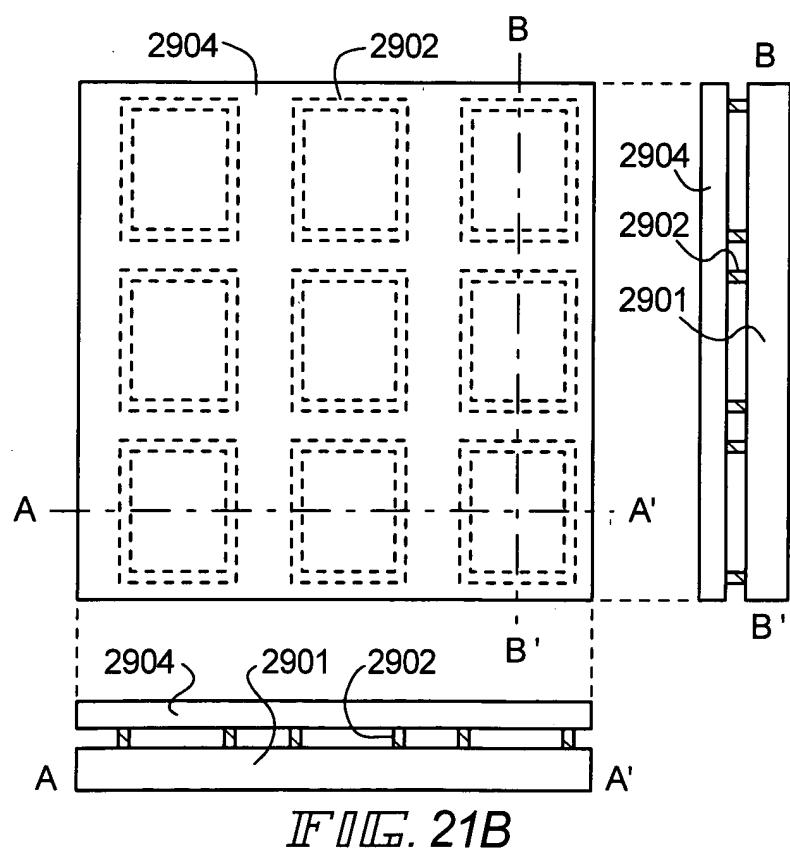
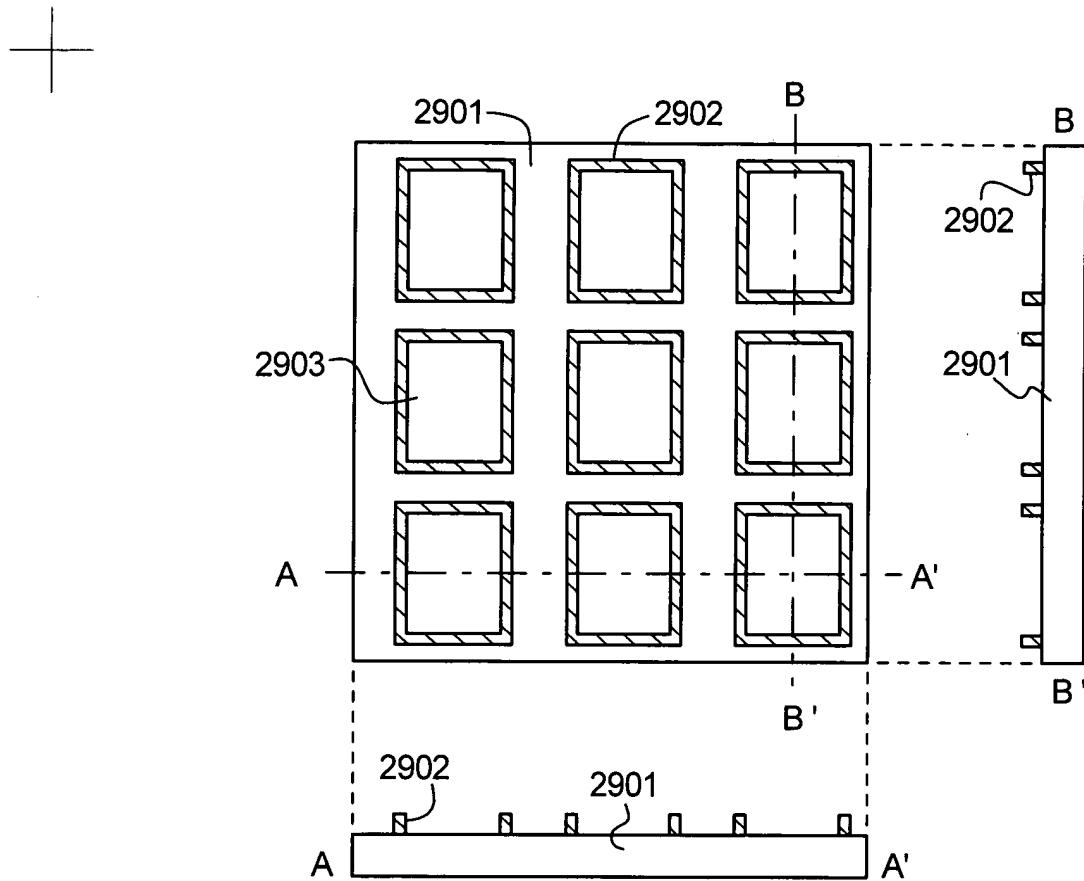
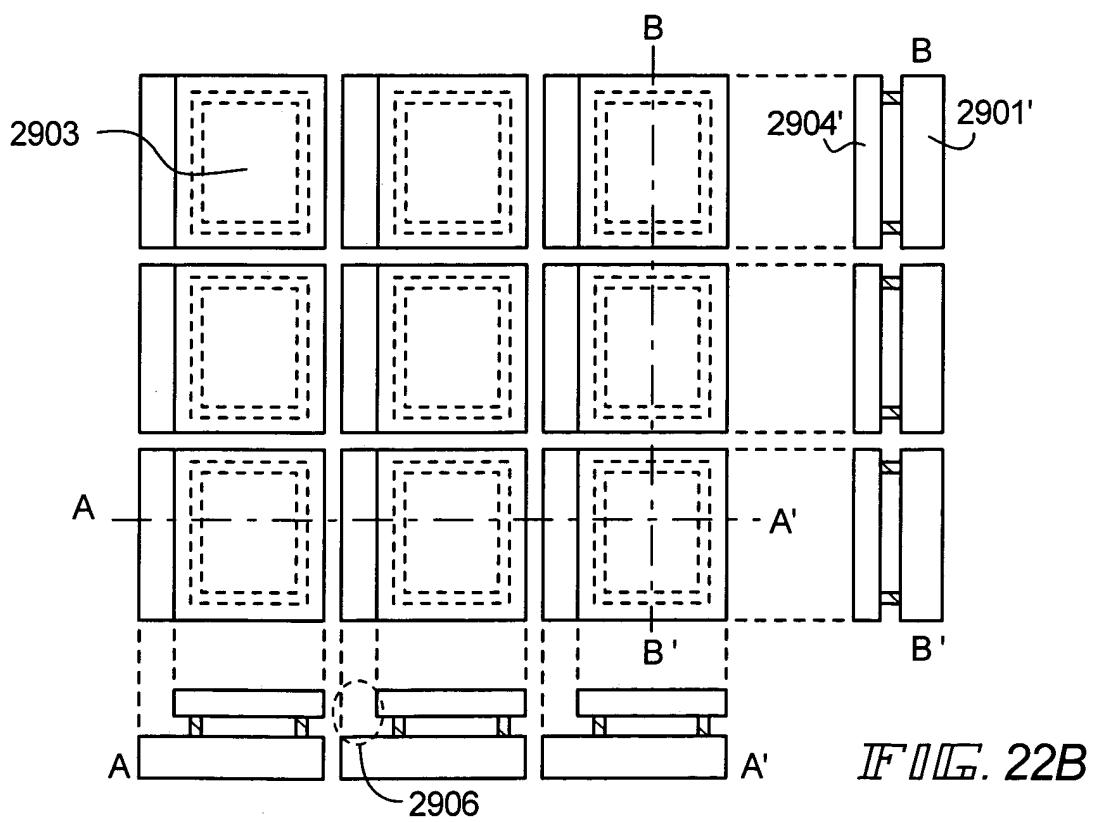
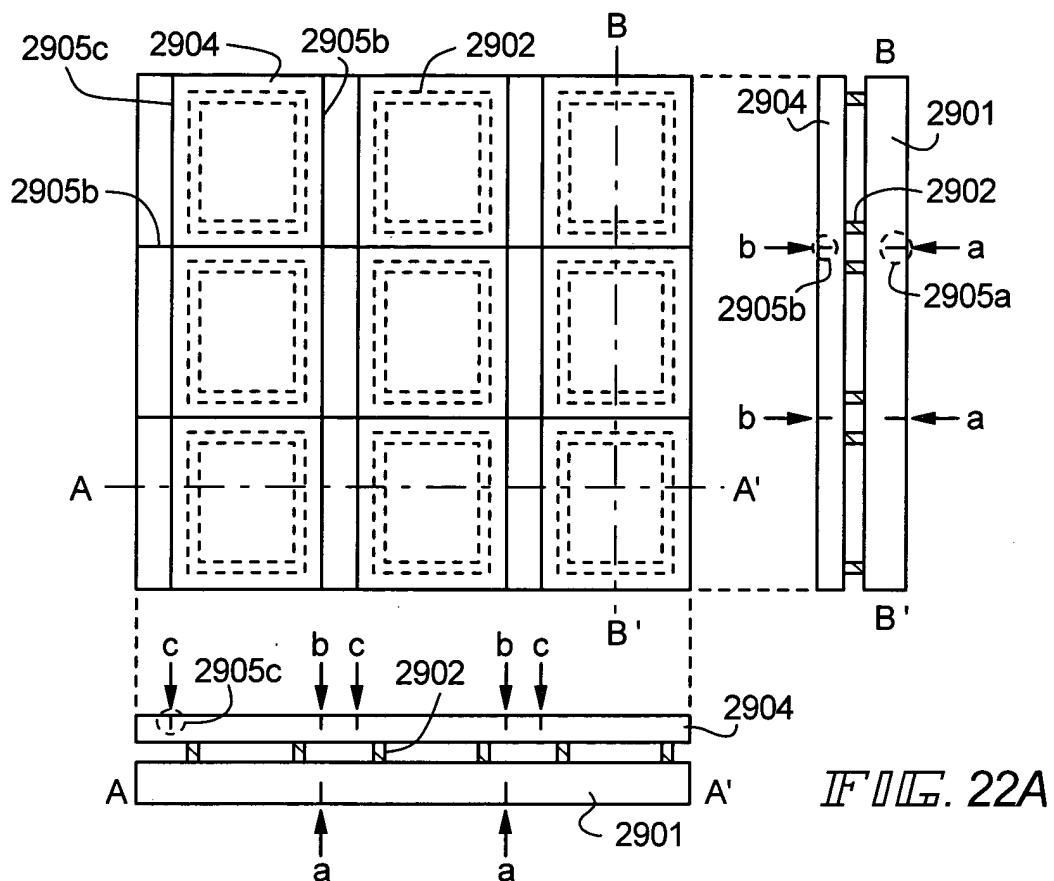
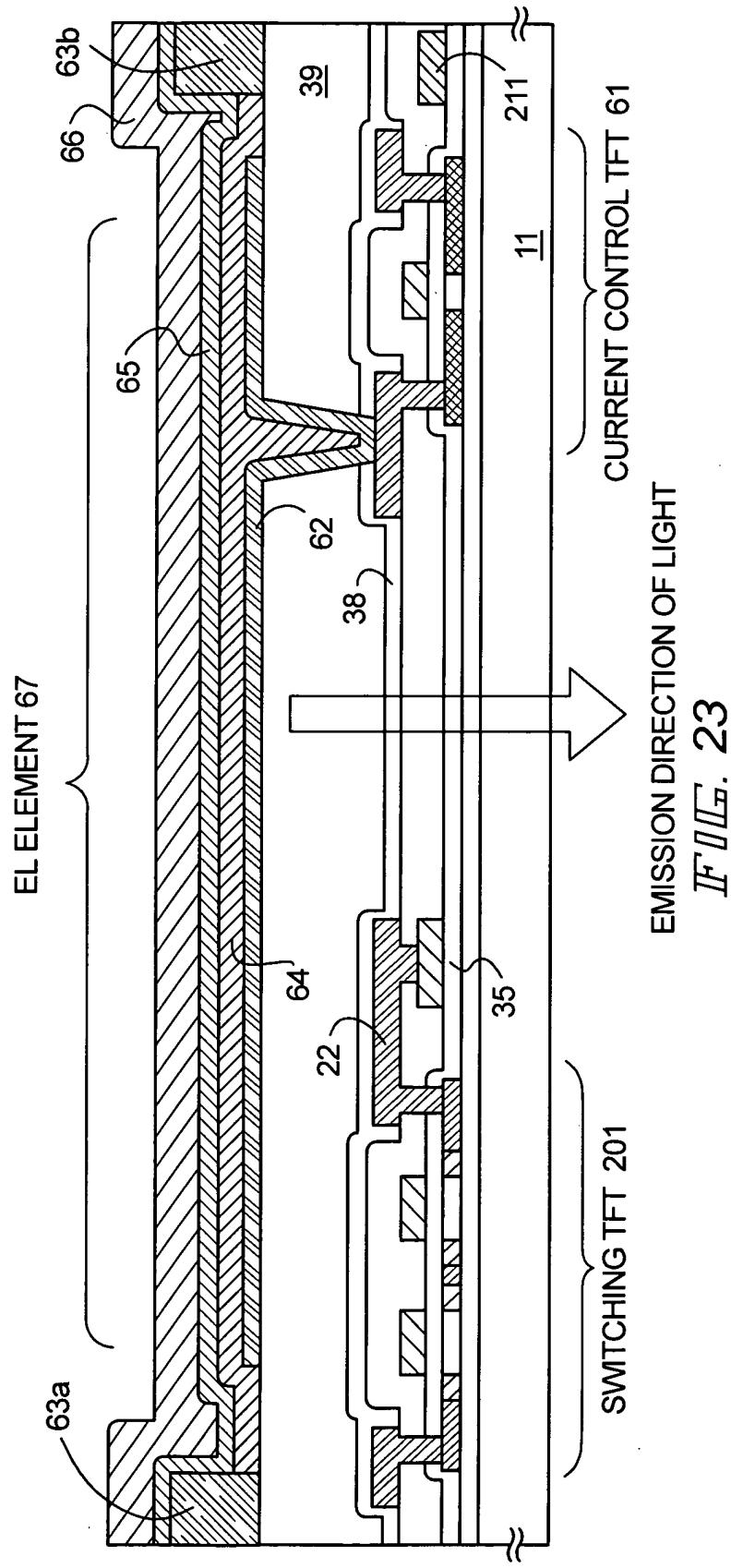


FIG. 20







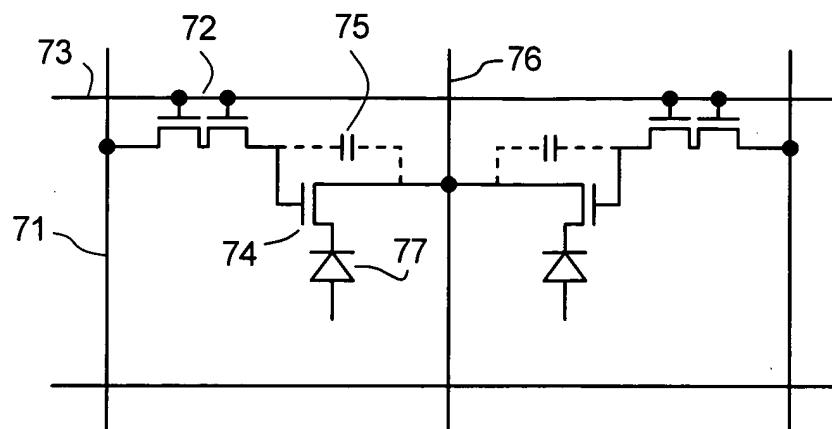


FIG. 24A

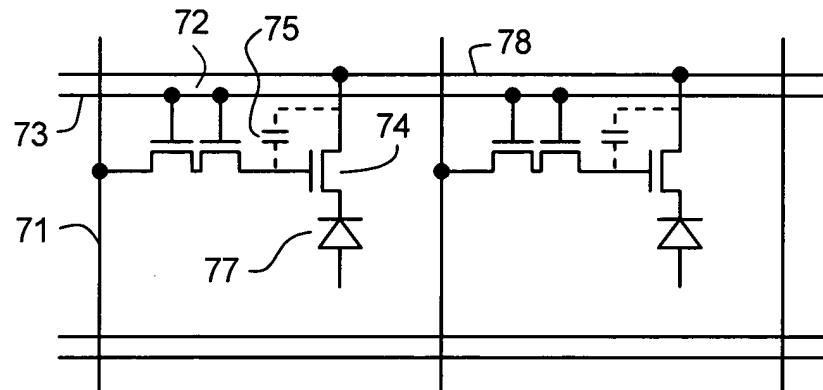


FIG. 24B

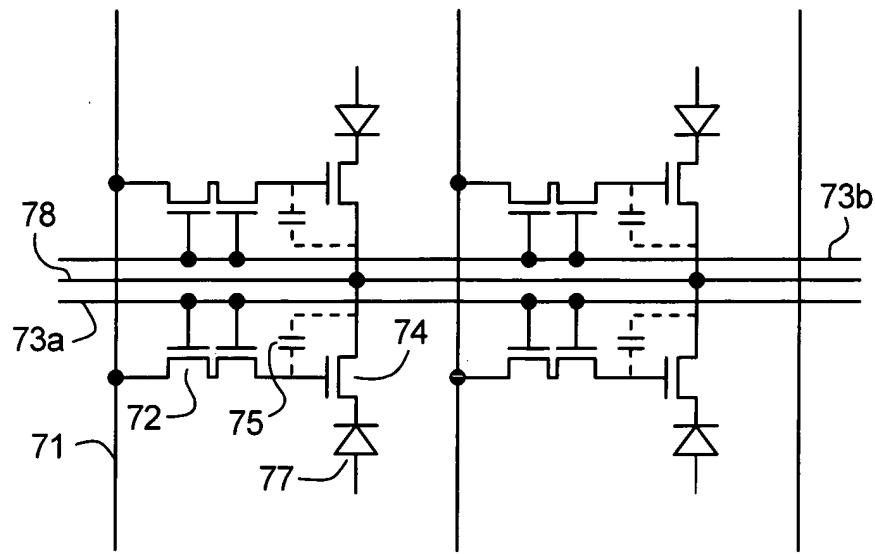


FIG. 24C

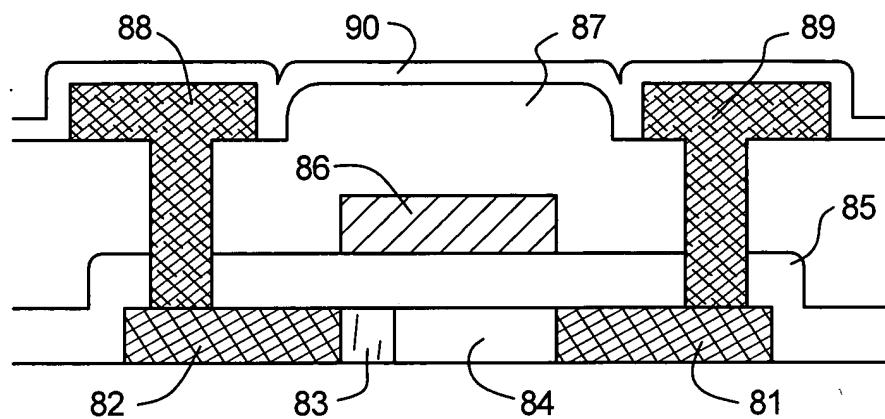


FIG. 25a

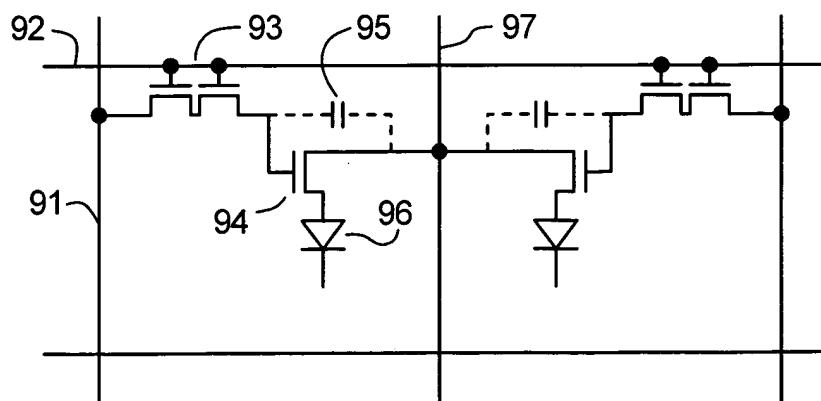


FIG. 25B